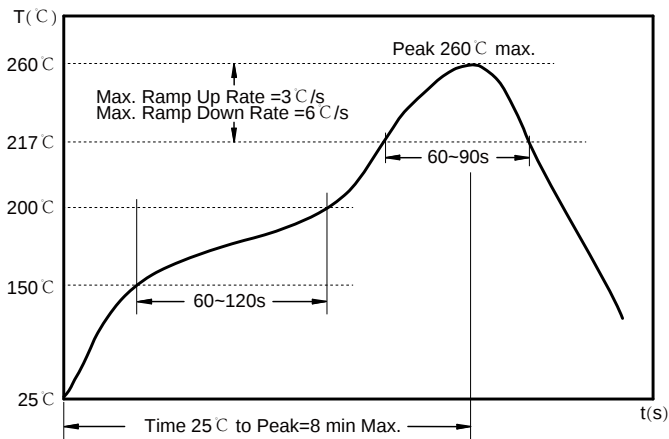


Soldering Reflow:



Preheat condition: 150 ~200 °C / 60~120 sec.

Allowed time above 217 °C: 60~90 sec.

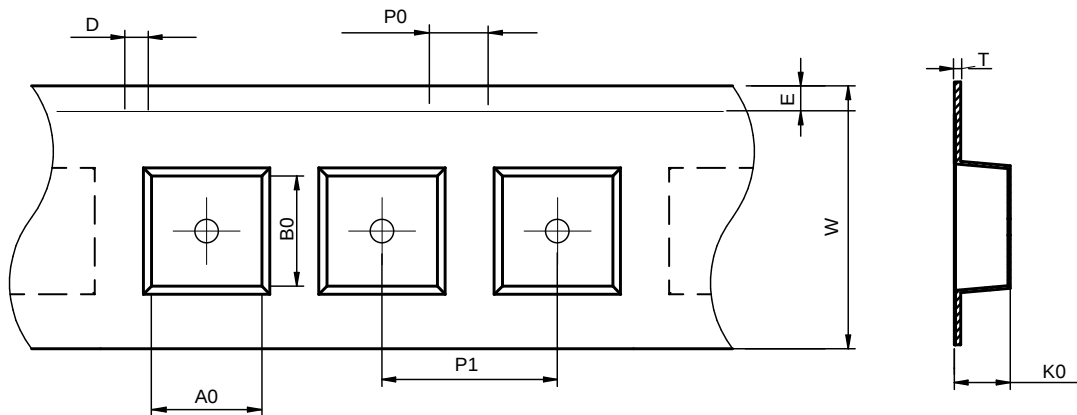
Max temperature: 260 °C.

Max time at max temperature: 10 sec.

Allowed Reflow time: 2x max.

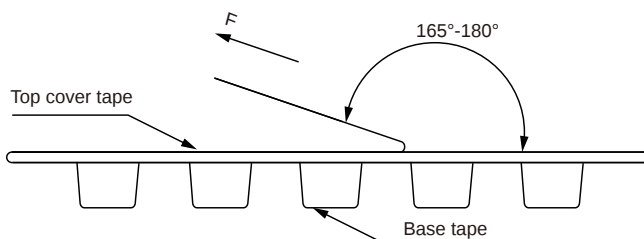
Packaging Information:

Tape Dimension:



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTE6050	7.0±0.1	6.8±0.1	1.5±0.1	4.0±0.1	12.0±0.1	16.0±0.3	5.3±0.1	1.75±0.1	0.35±0.05

Peel force of top cover tape:

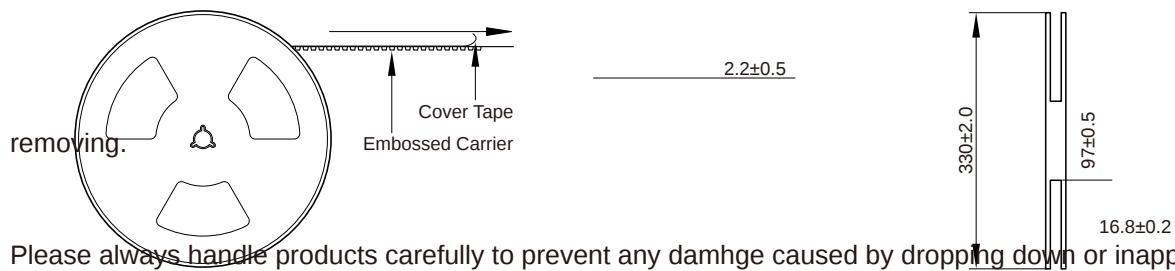


The peel force of top cover tape shall be between 0.1 to 1.3 N

Product Marking:

Marking	Printing (Inductance)
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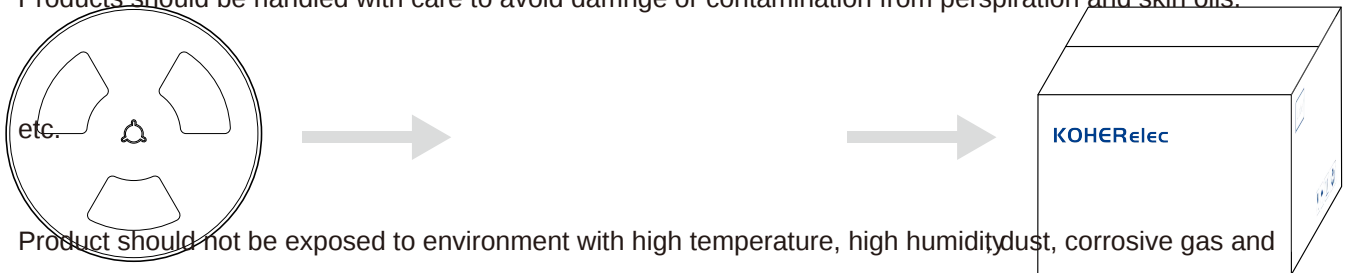
Reel Dimension: [mm]



Please always handle products carefully to prevent any damage caused by dropping down or inappropriate.

Packaging Quantity:

Products should be handled with care to avoid damage or contamination from perspiration and skin oils.



Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and

800 Pcs/Reel

2 Reel /Inner box(1600 Pcs)

3 Inner box/Carton box(4.8K Pcs)

terminal electrodes may deteriorate.

Cautions and Warnings:

Conditions (temperature: -5 to 35°C, humidity: 75% RH Max). If the storage period elapses, the soldering of the

Storage Conditions:

- The storage period is within 0 months after the completion of production. Be sure to follow the storage conditions.

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Operation Instructions:

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